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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL. NUM	FILING DATE	CLASS	SUBCLASS	GAU	EXAMINER
10074504	02/11/2003	438		2812	

**APPLICANTS: Todd Michael

**CONTINUING DATA VERIFIED:

THIS APPLN CLAIMS BENEFIT OF 60-268 337 02/12/2001
AND CLAIMS BENEFIT OF 60-279 256 03/27/2001
AND CLAIMS BENEFIT OF 60-311 609 08/09/2001
AND CLAIMS BENEFIT OF 60-323 649 09/19/2001
AND CLAIMS BENEFIT OF 60-332 696 11/13/2001
AND CLAIMS BENEFIT OF 60-333 724 11/28/2001
AND CLAIMS BENEFIT OF 60-340 454 12/07/2001

** FOREIGN APPLICATIONS VERIFIED:

PC PUB (DO NOT PUBLISH) <input checked="" type="checkbox"/>	RESCIND <input type="checkbox"/>	
Foreign priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no		ATTORNEY DOCKET NO
35 USC 119 conditions met: <input type="checkbox"/> yes <input checked="" type="checkbox"/> no		ASIMEX 067A
Verified and Acknowledged Exam pers. initials		
TITLE : Process for deposition of semiconductor films		

NOTICE OF ALLOWANCE MAILED		Assistant Examiner	CLAIMS ALLOWED		
			Total Claims	Print Claim for O.G	
ISSUE FEE		Primary Examiner	DRAWING		
Amount Due	Date Paid		Sheets Drwg.	Figs.Drwg.	Print Fig.
<input type="checkbox"/> TERMINAL DISCLAIMER		PREPARED FOR ISSUE	Application Examiner		
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